

C1210J334K5RACTU

Aliases (C1210J334K5RAC7800) SMD Comm X7R FO, Ceramic, 0.33 uF, 10%, 50 VDC, X7R, SMD, MLCC, Open Mode, Temperature Stable, 1210, 1.5 mm



General Information		
Series	SMD Comm X7R FO	
Style	SMD Chip	
Description	SMD, MLCC, Open Mode, Temperature Stable	
Features	Open Mode, Temperature Stable	
RoHS	Yes	
Termination	Flexible Termination	
Marking	No	
AEC-Q200	No	
Typical Component Weight	50 mg	
Shelf Life	78 Weeks	
MSL	1	

0.33 uF

1 kHz 1.0Vrms

3.0303 GOhms

Dimensions	
Chip Size	1210
L	3.3mm +/-0.4mm
W	2.6mm +/-0.3mm
Т	0.95mm +/-0.20mm
S	1.5mm MIN
В	0.6mm +/-0.25mm

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Packaging Specifications		

W	2.6mm +/-0.3mm	Tolerance	10%
Т	0.95mm +/-0.20mm	Voltage DC	50 VDC
S	1.5mm MIN	Dielectric Withstanding Voltage	125 VDC
В	0.6mm +/-0.25mm	Temperature Range	-55/+125°C
		Temp. Coefficient	X7R
Packaging Specifications		Capacitance Change with	15%, 1kHz 1.0Vrms
Packaging	T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC Applied (TCC)	
Packaging Quantity 4000	Dissipation Factor	2.5% 1 kHz 1.0Vrms	
		Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours

Specifications

Measurement Condition

Insulation Resistance

Capacitance

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